AP1212

Dual USB High-Side Power Switch

■ Features

- Compliant to USB specifications
- Dual independent switches control
- 2.7V to 5.5V input voltage
- 500mA minimum continuous current per port
- 110mΩ typical on-resistance
- 1.25A maximum short circuit current limit
- Independent open-drain fault flag pins
- 110μA typical on-state supply current
- 1μA typical off-state supply current
- Output can be forced higher than input (off-state)
- Thermal shutdown
- 2.4V typical under voltage lockout (UVLO)
- 1ms turn-on (soft-start) and fast turn-off
- Enable active-high (H) or active-low (L)
- 8-pin SOP and PDIP packages

■ Applications

- USB hubs
- Hot plug-in power supplies
- Battery-charger circuits

■ General Description

The AP1212 series are dual integrated high-side power switch with independent enable and flag functions, optimized for self-powered and bus-powered Universal Serial Bus (USB) applications. The AP1212 series support the following USB requirements: each switch channel supplies up to 500mA as required by USB downstream devices; the switch's low on-resistance meets USB voltage drop requirements; fault current is limited to typically 1000mA, well below the UL 25VA safety requirements; and a flag output is available to indicate fault conditions to the local USB controller. Soft start eliminates the momentary voltage drop on the upstream port that may occur when the switch is enabled in bus-powered applications.

Additional features include thermal shutdown to prevent catastrophic switch failure from high-current loads, under voltage lockout (UVLO) to ensure that the device remains off unless there is a valid input voltage present, and 3.3V and 5V logic compatible enable inputs.
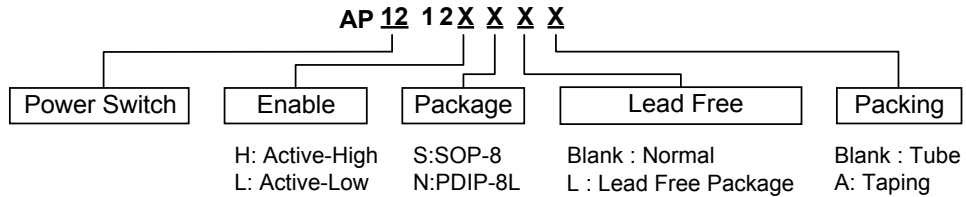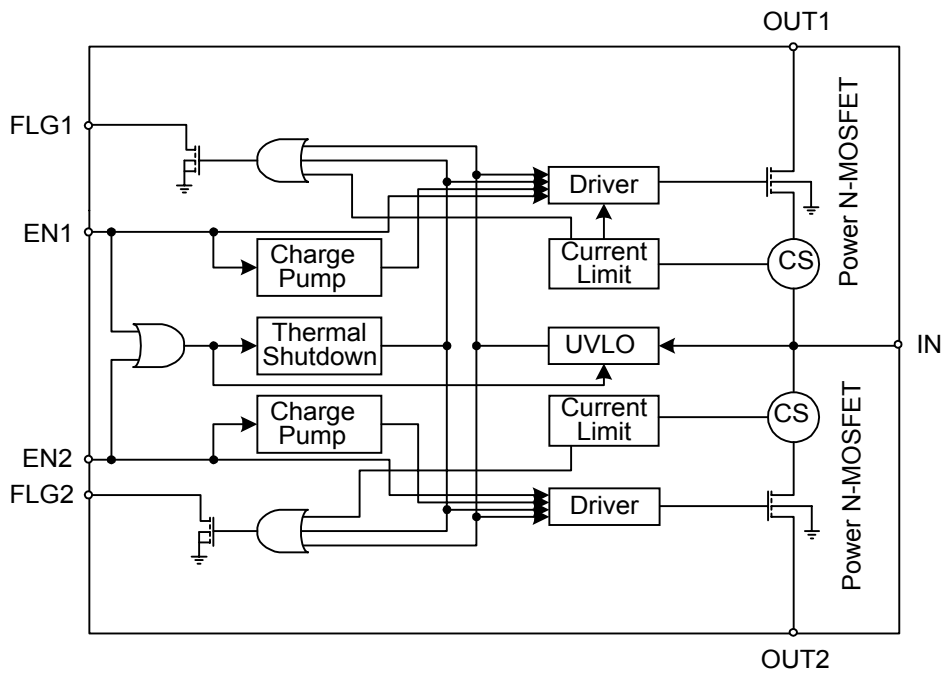
■ Pin Assignments

(Top View)

PDIP/SOP
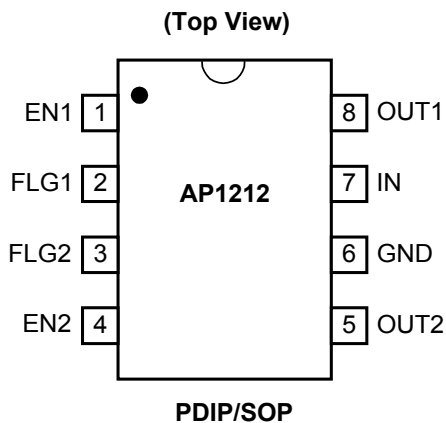
■ Pin Descriptions

Name	Description
EN1 EN2	Enable: Logic-compatible enable input. (H: active high, L: active low). Do not float.
FLG1 FLG2	Fault Flag: Active-low, open-drain output. Indicates over current, UVLO, and thermal shutdown.
GND	Supply return.
IN	Supply Input: Output MOSFET drain. Also supplies IC's internal circuitry. Connect to positive supply.
OUT1 OUT2	Switch Output: Output MOSFET source. Typically connect to switched side of load.

Dual USB High-Side Power Switch

■ Ordering Information

AP <u>12</u> 1 2 <u>X</u> <u>X</u> <u>X</u> <u>X</u>

| Power Switch | Enable | Package | Lead Free | Packing |

H: Active-High   S:SOP-8   Blank : Normal   Blank : Tube
L: Active-Low   N:PDIP-8L   L : Lead Free Package   A: Taping

■ Block Diagram

■ Absolute Maximum Ratings (Note 1)

Symbol	Parameter	Rating	Unit
V_{IN}	Supply Voltage	+7	V
V_{FLG}	Fault Flag Voltage	+7	V
I_{FLG}	Fault Flag Current	50	mA
V_{OUT}	Output Voltage	+7	V
V_{EN}	Control Input Range	−0.3 to V_{IN} +2	V
T_{ST}	Storage Temperature	-65 to +150	^oC
T_{LEAD}	Lead Temperature	260	^oC
ESD Rating	Note 3	4	KV

Dual USB High-Side Power Switch

■ Operating Ratings (Note 2)

Symbol	Parameter	Rating	Unit
V_{IN}	Supply Voltage	+2.7 to +5.5	V
T_A	Ambient Operating Temperature	-40 to +85	^oC
Θ_{JA}	Thermal Resistance SOP	120	$^oC/W$
Θ_{JA}	Thermal Resistance PDIP	100	$^oC/W$

■ Electrical Characteristics (Under the conditions of V_{IN}=+5V and T_A=25^oC, unless otherwise specified.)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_{CC}	Supply Current	switch off, OUT = open (Note 4)		0.50	5	µA
		all switches on, OUT = open (Note 4)		110	160	µA
V_{IT}	Enable Input Threshold	(Note 4)	0.8	1.7	2.40	V
I_{EN}	Enable Input Current	V_{EN} =0V to 5.5V	-1	± 0.01	1	µA
C_{EN}	Enable Input Capacitance			1		pF
$R_{DS(ON)}$	Switch Resistance	V_{IN} =2.7V ~ 5.5V, I_{OUT} =500mA, each switch		110	140	mΩ
T_{OND}	Output Turn-On Delay	R_L =10Ω each output		30		µS
T_R	Output Turn-On Rise Time	R_L =10Ω each output		1		mS
T_{OFFD}	Output Turnoff Delay	R_L =10Ω each output		0.5	10	µS
T_F	Output Turnoff Fall Time	R_L =10Ω each output		0.5	10	µS
I_{LEAK}	Output Leakage Current	each output (output disabled)			10	µA
I_{OUT}	Continuous Load Current	each output	0.6			A
I_{OS}	Short-circuit Current Limit	Each output (enable into load), V_{OUT}=0V	0.8	1.0	1.25	A
I_{LIM}	Current-Limit Threshold	Ramped load applied to enabled output	1.0	1.2	1.4	A
T_{TS}	Over-temperature Shutdown Threshold	T_J increasing		140		^oC
		T_J decreasing		130		^oC
R_{FO}	Error Flag Output Resistance	V_{IN} = 5V, I_L = 10mA		10	25	Ω
		V_{IN} = 3.3V, I_L = 10mA		15	40	Ω
I_{FOH}	Error Flag Off Current	V_{FLAG} = 5V		0.01	1	µA
UVLO	UVLO Threshold	V_{IN} = increasing		2.5		V
		V_{IN} = decreasing		2.3		V

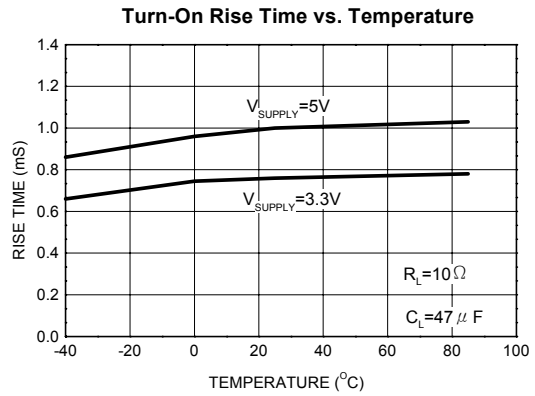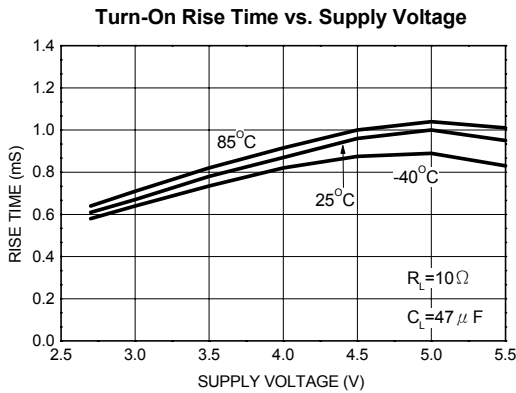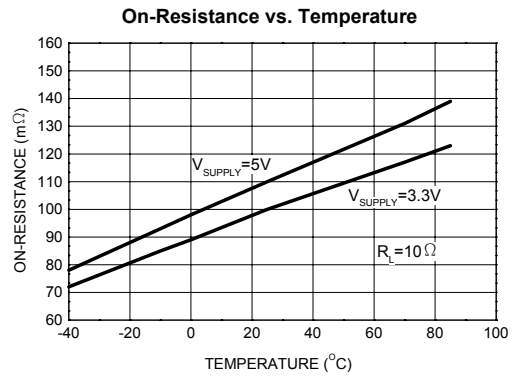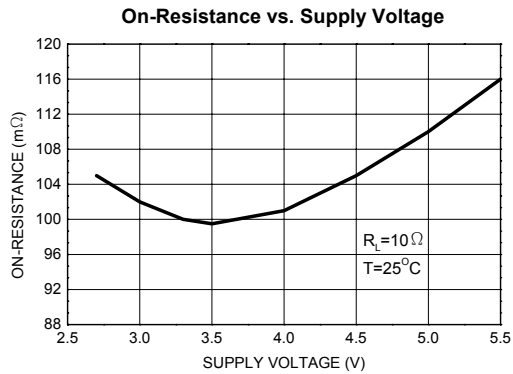**Note 1.** Exceeding the absolute maximum rating may damage the device.
Note 2. The device is not guaranteed to function outside its operating rating.
Note 3. Devices are ESD sensitive. Handling precautions are recommended. Human body model, 1.5k in series with 100pF.
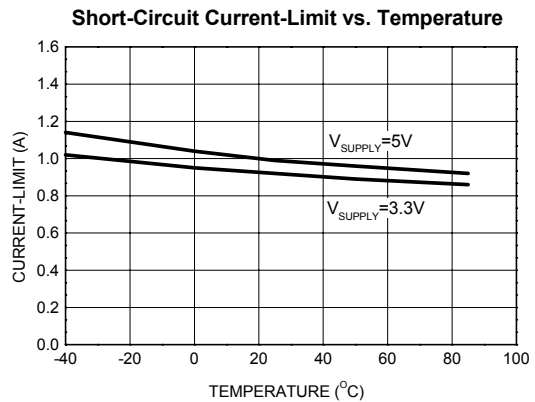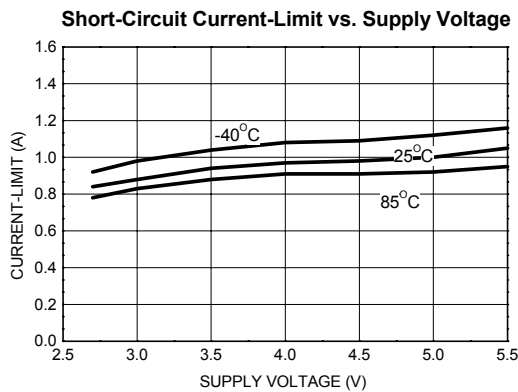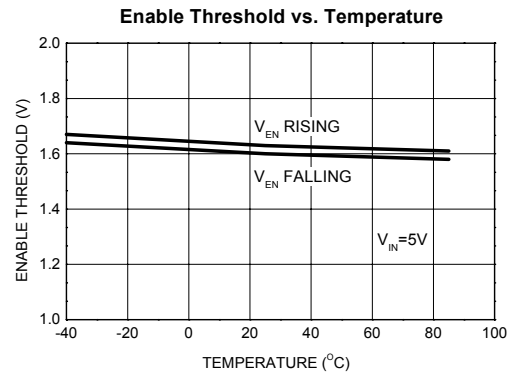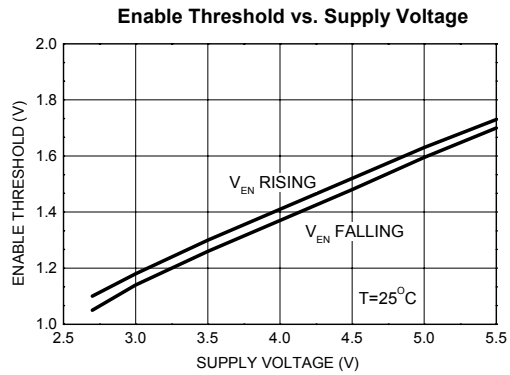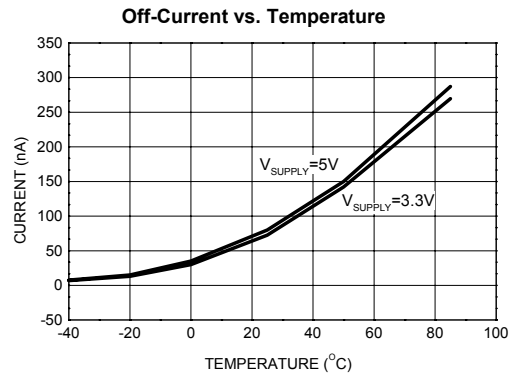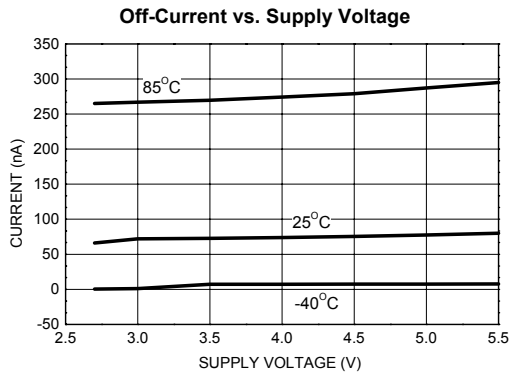**Note 4.** Off is $V_{EN} \leqq 0.8V$ and on is $V_{EN} \geqq 2.4V$ for the AP1212H. Off is $V_{EN} \geqq 2.4V$ and on is $V_{EN} \leqq 0.8V$ for the AP1212L.
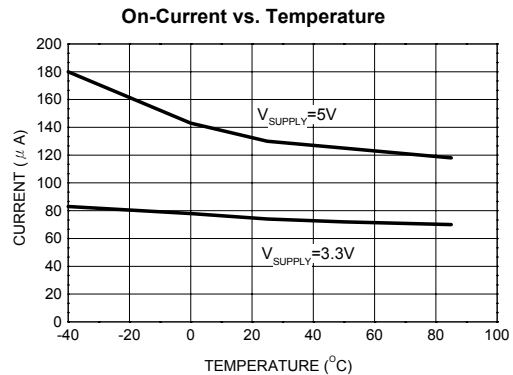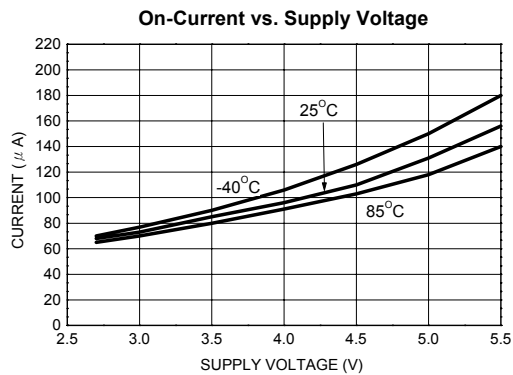
■ Typical Performance Characteristics
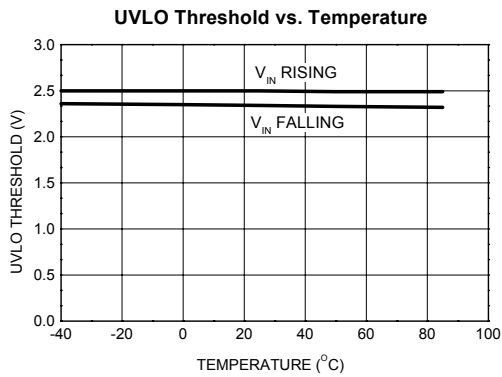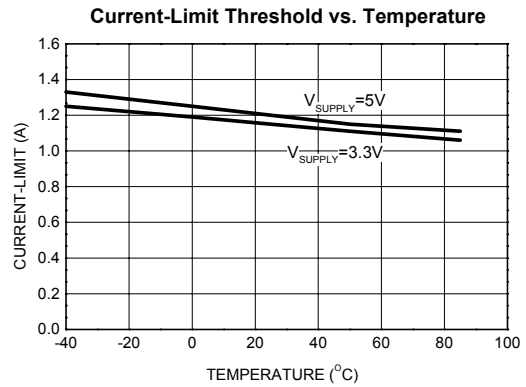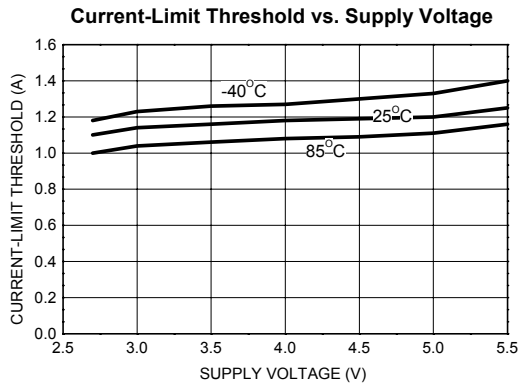
On-Resistance vs. Supply Voltage

On-Resistance vs. Temperature

Turn-On Rise Time vs. Supply Voltage

Turn-On Rise Time vs. Temperature

On-Current vs. Supply Voltage

On-Current vs. Temperature

■ Typical Performance Characteristics (Continued)

Off-Current vs. Supply Voltage

Off-Current vs. Temperature

Enable Threshold vs. Supply Voltage

Enable Threshold vs. Temperature

Short-Circuit Current-Limit vs. Supply Voltage

Short-Circuit Current-Limit vs. Temperature

■ **Typical Performance Characteristics (Continued)**

Current-Limit Threshold vs. Supply Voltage

Current-Limit Threshold vs. Temperature

UVLO Threshold vs. Temperature

■ Functional Characteristics

Turn-On/Turn-Off (AP1212H)
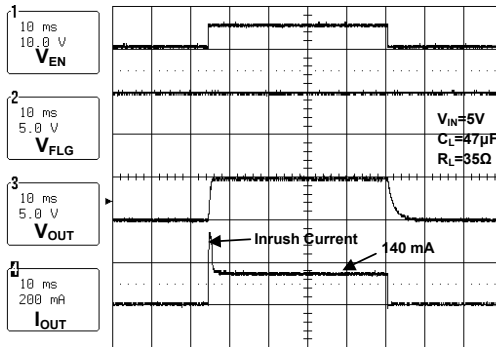
Turn-On (AP1212H)
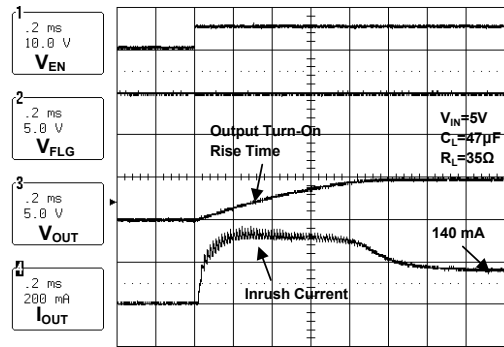
Turn-Off (AP1212H)
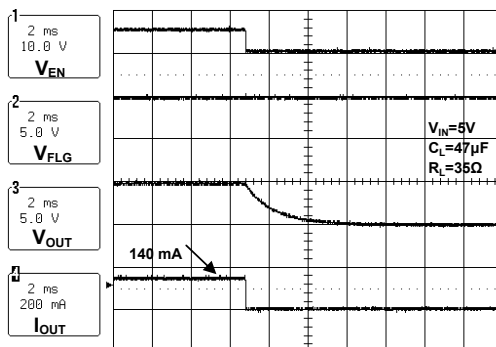
Enabled Into Short (AP1212H)
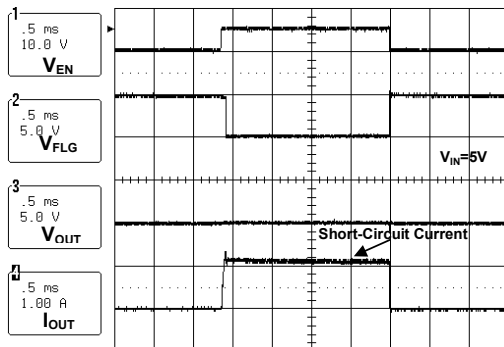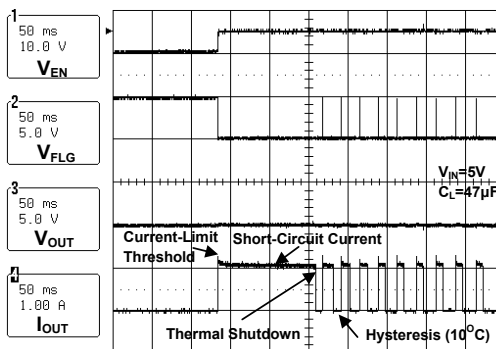
Current-Limit Response (AP1212H)

Current-Limit Response (AP1212H)
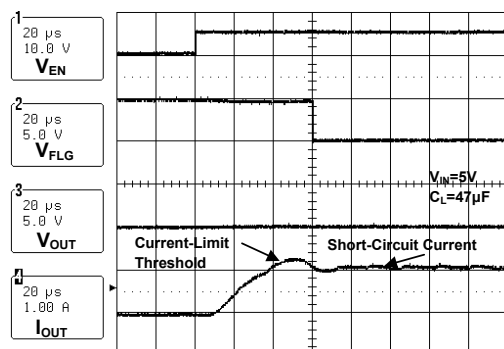
■ Typical Application Circuit
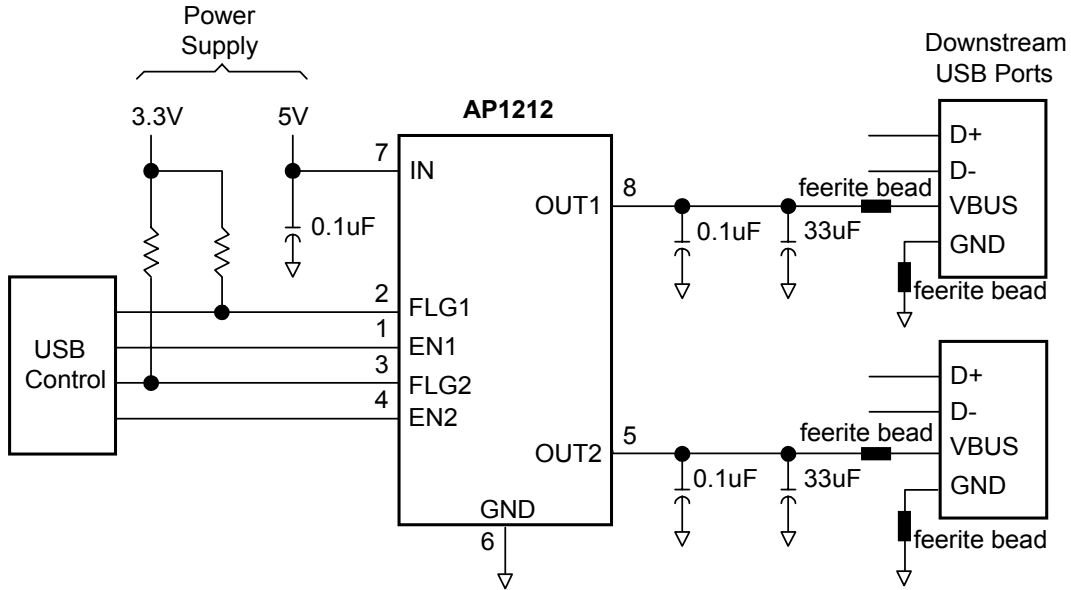
■ Test Circuit
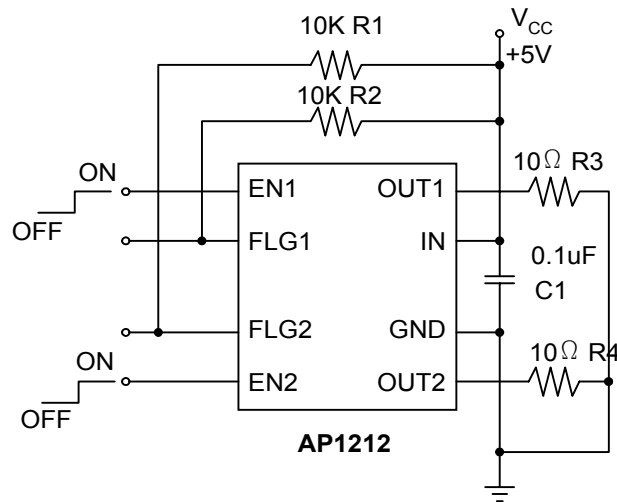
■ Function Description

Error Flag
An open-drained output of N-channel MOSFET, the FLG output is pulled low to signal the following fault conditions: input undervoltage, output current limit, and thermal shutdown.

Current Limit
The current limit threshold is preset internally. It protects the output MOSFET switches from damage due to undesirable short circuit conditions or excess inrush current often encountered during hot plug-in. The low limit of the current limit threshold of the AP1212 allows a minimum current of 0.5A through the MOSFET switches. A current limit condition will signal the error flag.

Thermal Shutdown
When the chip temperature exceeds 140ºC for any reason other than overcurrent fault of either one of the two MOSFET switches, the thermal shutdown function turns off both MOSFET switches and signal the error flag. A hysteresis of 10ºC prevents the MOSFETs from turning back on until the chip temperature drops to below 130ºC.

Supply Filtering
A 0.1µF to 1µF bypass capacitor from IN to GND, located near the device, is strongly recommended to control supply transients. Without a bypass capacitor, an output short may cause sufficient ringing on the input (from supply lead inductance) to damage internal control circuitry.

Transient Droop Requirements
USB support dynamic attachment (hot plug-in) of peripherals. A current surge is caused by the input capacitance of downstream device. Ferrite beads are recommended in series with all power and ground connector pins. Ferrite beads reduce EMI and limit the inrush current during hot-attachment by filtering high-frequency signals.
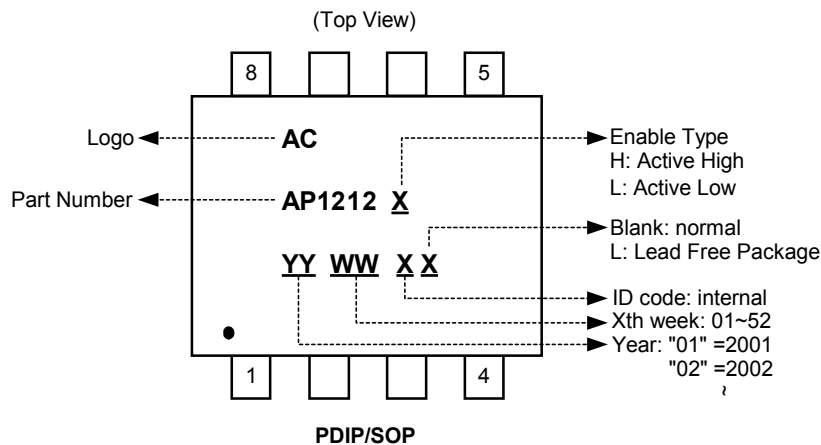
Short Circuit Transient
Bulk capacitance provides the short-term transient current needed during a hot-attachment event. With a 33µF, 16V tantalum or 100µF, 10V electrolytic capacitor mounted close to downstream connector per port should provide transient drop protection.

Printed Circuit Layout
The power circuitry of USB printed circuit boards requires a customized layout to maximize thermal dissipation and to minimize voltage drop and EMI.

■ Marking Information

(Top View)

| | | | |
| 8 | | | 5 |

Logo ← AC

Part Number ← AP1212 X

YY WW X X

→ Enable Type
H: Active High
L: Active Low

→ Blank: normal
L: Lead Free Package

→ ID code: internal
→ Xth week: 01~52
→ Year: "01" =2001
"02" =2002

| | | | |
| 1 | | | 4 |

PDIP/SOP

■ Package Information

(1) Package Type: PDIP-8L

E-PIN Ø0.118 inch

PIN #1 INDENT Ø0.025 DEEP 0.006-0.008 inch

15°(4X)

7°(4X)
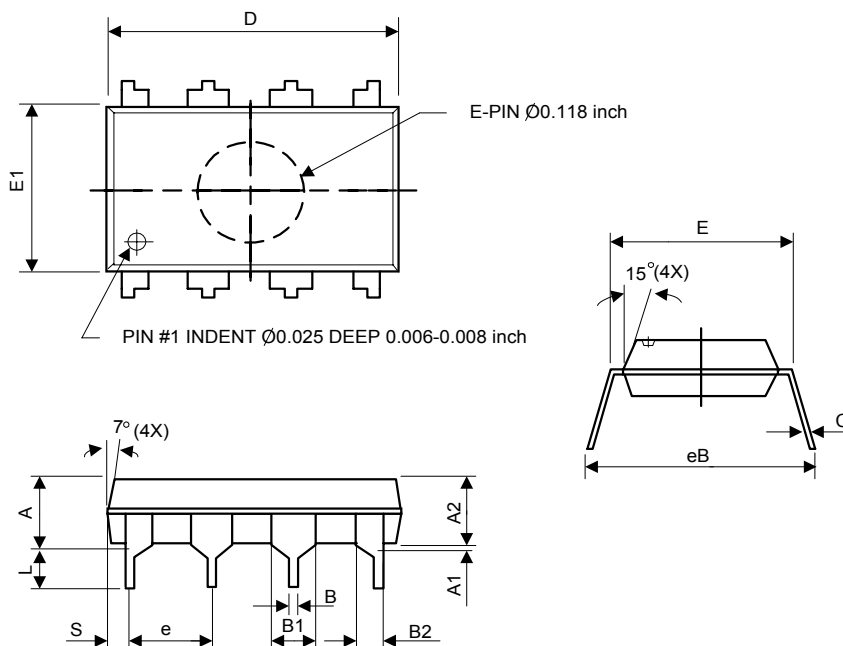
Symbol	Dimensions in millimeters			Dimensions in inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	-	-	5.33	-	-	0.210
A1	0.38	-	-	0.015	-	-
A2	3.1	3.30	3.5	0.122	0.130	0.138
B	0.36	0.46	0.56	0.014	0.018	0.022
B1	1.4	1.52	1.65	0.055	0.060	0.065
B2	0.81	0.99	1.14	0.032	0.039	0.045
C	0.20	0.25	0.36	0.008	0.010	0.014
D	9.02	9.27	9.53	0.355	0.365	0.375
E	7.62	7.94	8.26	0.300	0.313	0.325
E1	6.15	6.35	6.55	0.242	0.250	0.258
e	-	2.54	-	-	0.100	-
L	2.92	3.3	3.81	0.115	0.130	0.150
eB	8.38	8.89	9.40	0.330	0.350	0.370
S	0.71	0.84	0.97	0.028	0.033	0.038

■ Package Information (Continued)

(2) Package Type: SOP-8L

VIEW "A"
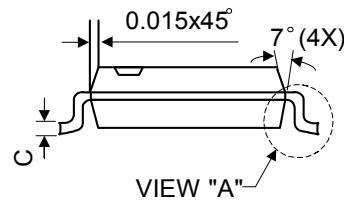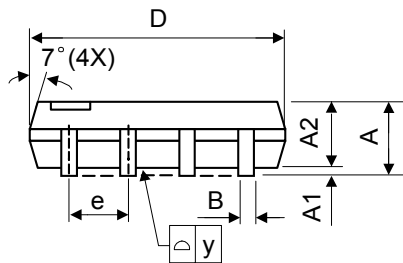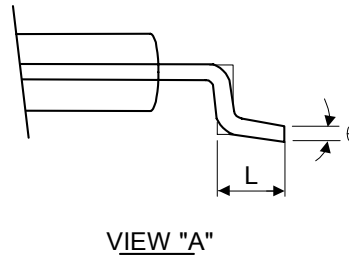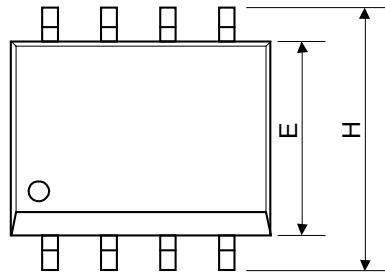
Symbol	Dimensions In Millimeters			Dimensions In Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	1.40	1.60	1.75	0.055	0.063	0.069
A1	0.10	-	0.25	0.040	-	0.100
A2	1.30	1.45	1.50	0.051	0.057	0.059
B	0.33	0.41	0.51	0.013	0.016	0.020
C	0.19	0.20	0.25	0.0075	0.008	0.010
D	4.80	5.05	5.30	0.189	0.199	0.209
E	3.70	3.90	4.10	0.146	0.154	0.161
e	-	1.27	-	-	0.050	-
H	5.79	5.99	6.20	0.228	0.236	0.244
L	0.38	0.71	1.27	0.015	0.028	0.050
y	-	-	0.10	-	-	0.004
θ	0°	-	8°	0°	-	8°